

<TRANSISTOR ARRAY>

M54522FP

8-UNIT 400mA DARLINGTON TRANSISTOR ARRAY WITH CLAMP DIODE SINK TYPE

DESCRIPTION

M54522FP is an eight-circuit Darlington transistor arrays with clamping diodes. The circuits are made of NPN transistors. Both the semiconductor integrated circuits perform high-current driving with extremely low input-current supply.

FEATURES

- High breakdown voltage (BVCEO ≥ 40V)
- High-current driving (Ic(max) = 400mA)
- With clamping diodes
- Driving available with PMOS IC output

APPLICATIONS

Drives of relays and printers, digit drives of indication elements (LEDs and lamps), and interfaces between microcomputer output and high-current or high-voltage systems

FUNCTION

The M54522FP each have eight circuits consisting of NPN Darlington transistors. This ICs have resistance of $20k\Omega$ between input transistor bases and input pins.

A spike-killer clamping diode is provided between each output pin (collector) and COM pin. The output transistor emitters are all connected to the GND pin (pin 10).

The collector current is 400mA maximum. Collector-emitter supply voltage is 40V maximum.



CIRCUIT DIAGRAM



ABSOLUTE MAXIMUM RATINGS (Unless otherwise noted, $Ta = -20 \sim +75^{\circ}C$)

Symbol	Parameter	Conditions	Ratings	Unit
VCEO	Collector-emitter voltage	Output , H	-0.5 ~ +40	V
Ic	Output current	Current per circuit output, L	400	mA
Vi	Input voltage		-0.5 ~ +40	V
IF	Clamping diode forward current		400	mA
VR	Clamping diode reverse voltage		40	V
Pd	Power dissipation	Ta = 25° C, when mounted on board	1.10	W
Topr	Operating temperature		-20 ~ +75	°C
Tstg	Storage temperature		-55 ~ +125	°C

RECOMMENDED OPERATING (Unless otherwise noted, Ta = -20 ~ +75°C)

Symbol	Parameter			Linit		
Symbol			min	typ	max	Unit
Vo	Output voltage	0	-	40	V	
	Collector current (Current per 1 circuit when 8 circuits are coming on simultaneously)	Duty Cycle no more than 5%	0	_	400	mA
		Duty Cycle no more than 20%	0	—	200	
	"H" input voltage	Ic <u><</u> 400mA	8		30	V
		Ic <u><</u> 200mA	4	-		
VIL	"L" input voltage		0	—	0.5	V

ELECTRICAL CHARACTERISTICS (Unless otherwise noted, $Ta = -20 \sim +75^{\circ}C$)

Symbol	Parameter	Test conditions	Limits			Linit
			min	typ *	max	
V (BR)CEO	Collector-emitter breakdown voltage	Iceo = 100 μ A	40	_	—	V
VCE(sat)	Collector-emitter saturation voltage	$V_{I} = 8V, I_{C} = 400 mA$	—	1.15	2.4	V
		$V_{I} = 4V, I_{C} = 200 \text{mA}$	—	0.95	1.6	v
li	Input current	VI = 17V	0.3	0.85	1.8	mA
VF	Clamping diode forward voltage	IF = 400mA	_	1.5	2.4	V
lr	Clamping diode reverse current	VR = 40V	—	_	100	μA
hfe	DC amplification factor	Vce = 4V, Ic = 300mA, Ta = 25°C	1000	8000	_	_

* : The typical values are those measured under ambient temperature (Ta) of 25°C.

There is no guarantee that these values are obtained under any conditions.

SWITCHING CHARACTERISTICS (Unless otherwise noted, Ta = 25° C)

Symbol	Parameter	Test conditions	Limits			Linit
			min	typ	max	Unit
ton	Turn-on time	CL = 15pF(note 1)	_	30	_	ns
toff	Turn-off time		—	930	_	ns

TIMING DIAGRAM

NOTE 1 TEST CIRCUIT



(1) Pulse generator (PG) characteristics: PRR = 1kHz,

tw = 10 μ s, tr = 6ns, tf = 6ns, Zo = 50 Ω ,Vi N= 0 to 8V

(2) Input-output conditions : $R_L = 25 \Omega$, $V_O = 10V$

(3) Electrostatic capacity CL includes floating capacitance at connections and input capacitance at probes

INPUT 50%



TYPICAL CHARACTERISTICS





Collector saturation voltage VCE(sat)(V)











Grounded Emitter Transfer Characteristics





PACKAGE OUTLINE



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